

AULU2905-VB Datasheet

N-Channel 60 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|--|--------------------|-----------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | Q _g (Typ.) | | | |
| 60 | $0.032 \text{ at V}_{GS} = 10 \text{ V}$ | 35 ^d | 21.7 | | | |
| 00 | 0.037 at V _{GS} = 4.5 V | 30 ^d | 21.7 | | | |

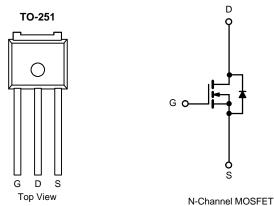
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % $\rm R_{\rm g}$ and UIS Tested Compliant to RoHS Directive 2002/95/EC





- Power Supply
 - Secondary Synchronous Rectification
- DC/DC Converter



| ABSOLUTE MAXIMUM RATING | $T_C = 25 ^{\circ}C$, unless other | erwise noted | | | |
|---|--------------------------------------|-----------------------------------|-------------------|-----|--|
| Parameter | Symbol | Limit | Unit | | |
| Drain-Source Voltage | V _{DS} | 60 | V | | |
| Gate-Source Voltage | V _{GS} | ± 20 |] v | | |
| Continuous Drain Current (T _{.I} = 150 °C) | T _C = 25 °C | 1_ | 35 ^d | | |
| Continuous Diairi Current (1) = 130 °C) | T _C = 70 °C | I _D | 30 ^d | Α | |
| Pulsed Drain Current | | I _{DM} | 100 | Α . | |
| Avalanche Current | | I _{AS} | 40 | 1 | |
| Single Avalanche Energy ^a | L = 0.1 mH | E _{AS} | 80 | mJ | |
| Mariana Barra Birainatia a | T _C = 25 °C | В | 59.5 ^b | w | |
| Maximum Power Dissipation ^a | T _A = 25 °C ^c | $ P_D$ $-$ | 2.7 | VV | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|-------------------|-------|------|--|--|
| Parameter | Symbol | Limit | Unit | | |
| Junction-to-Ambient (PCB Mount) ^c | R _{thJA} | 46 | °C/W | | |
| Junction-to-Case (Drain) | R _{thJC} | 2.1 | C/VV | | |

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

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| SPECIFICATIONS $T_J = 25^{\circ}$ | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|----------------------|---|---------|-------|--------|-------|
| Static | Зуппол | rest conditions | IVIIII. | тур. | IVIAA. | Offic |
| | ., | V 0.V 1 050 A | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{DS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 60 | | | V |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$ | 2.0 | | 3.5 | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 250 | nA |
| | | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$ | | | 50 | μA |
| | | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$ | | | 250 | |
| On-State Drain Current ^a | $I_{D(on)}$ | $V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$ | 50 | | | Α |
| Drain-Source On-State Resistance ^a | D | $V_{GS} = 10 \text{ V}, I_{D} = 12 \text{ A}$ | | 0.032 | | Ω |
| Diam-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$ | | 0.037 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 10 A | | 110 | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, V _{DS} = 30 V, f = 1 MHz | | 1100 | | pF |
| Output Capacitance | C _{oss} | | | 281 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 130 | | |
| Tatal Cata Chausa C | Q _g | V _{DS} = 30 V, V _{GS} = 10 V, I _D = 10 A | | 46 | | nC |
| Total Gate Charge ^c | | | | 28 | | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$ | | 7 | | |
| Gate-Drain Charge ^c | Q _{gd} | | | 6.7 | | |
| Gate Resistance | R _g | f = 1 MHz | 0.4 | 2 | 4 | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | | | 8 | 16 | |
| Rise Time ^c | t _r | $V_{DD} = 30 \text{ V, R}_{1} = 1.5 \Omega$ | | 9 | 18 | ns |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$ | | 35 | 53 | |
| Fall Time ^c | t _f | Ç | | 9 | 18 | |
| Drain-Source Body Diode Ratings ar | | stics T _C = 25 °C ^b | | | - | |
| Continuous Current | I _S | | | | 50 | |
| Pulsed Current | | I _{SM} | | | 100 | Α |
| Forward Voltage ^a | V _{SD} | I _F = 10 A, V _{GS} = 0 V | | 0.75 | 1.5 | V |
| Reverse Recovery Time | t _{rr} | ·F .57.9.65 5 . | | 34 | 51 | ns |
| Peak Reverse Recovery Current | | $I_{\rm F} = 10 \text{ A}, dI/dt = 100 A/\mu s$ | | 2 | 3 | A |
| Reverse Recovery Charge | I _{RM(REC)} | 1 _F = 10 Λ, αι/αι = 100 Λ/μδ | | 34 | 51 | nC |

Notes:

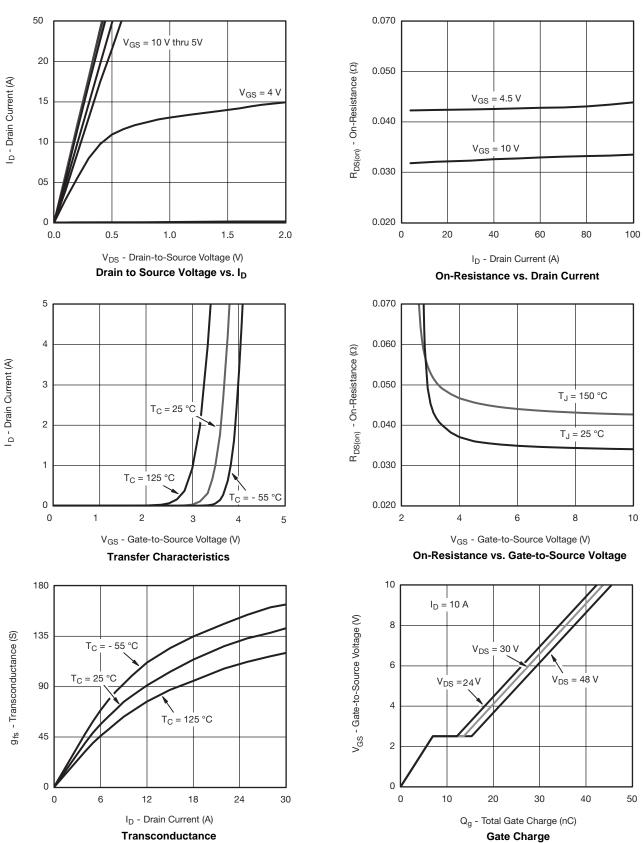
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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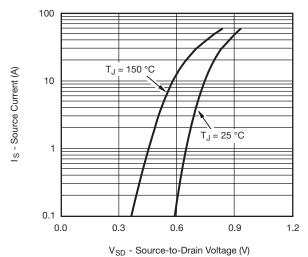


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

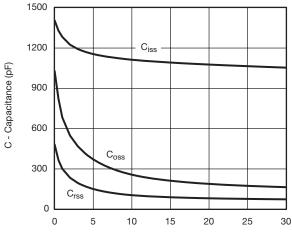




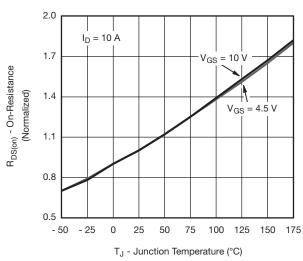
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



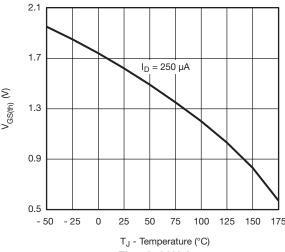
Source-Drain Diode Forward Voltage



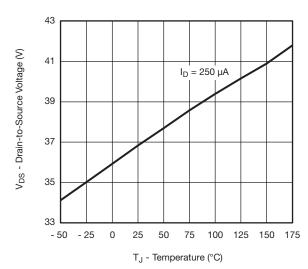
 V_{DS} - Drain-to-Source Voltage (V) $\label{eq:capacitance}$



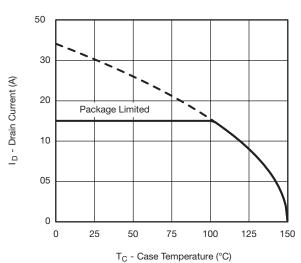
On-Resistance vs. Junction Temperature



Threshold Voltage



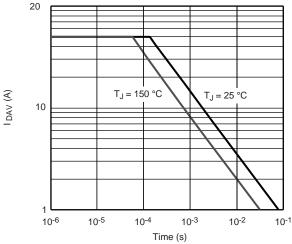
Drain Source Breakdown vs. Junction Temperature

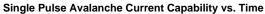


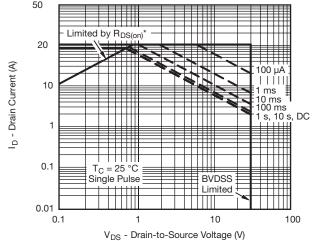
Current Derating



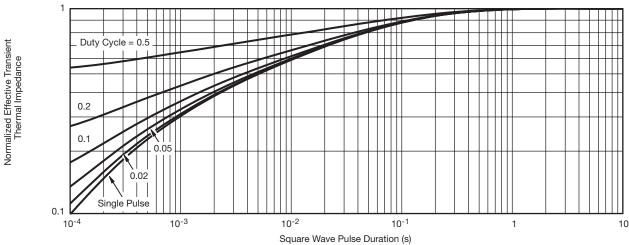
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified **Safe Operating Area**



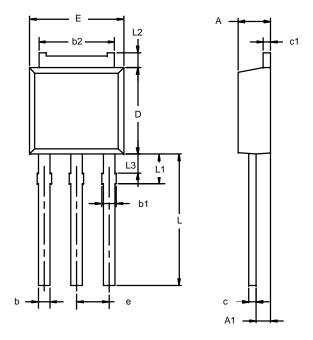
Normalized Thermal Transient Impedance, Junction-to-Case

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TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

| | MILLIMETERS INCHE | | | HES | |
|---|-------------------|------|-----------|-------|--|
| Dim | Min | Max | Min | Max | |
| Α | 2.21 | 2.38 | 0.087 | 0.094 | |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 | |
| b | 0.71 | 0.89 | 0.028 | 0.035 | |
| b1 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b2 | 5.23 | 5.43 | 0.206 | 0.214 | |
| С | 0.46 | 0.58 | 0.018 | 0.023 | |
| с1 | 0.46 | 0.58 | 0.018 | 0.023 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | |
| Е | 6.48 | 6.73 | 0.255 | 0.265 | |
| е | 2.28 BSC | | 0.090 BSC | | |
| L | 8.89 | 9.53 | 0.350 | 0.375 | |
| L1 | 1.91 | 2.28 | 0.075 | 0.090 | |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L3 | 1.15 | 1.52 | 0.045 | 0.060 | |
| ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346 | | | | | |

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